

DECLARATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "THREE-DIMENSIONAL BIORESORBABLE SCAFFOLDS FOR TISSUE ENGINEERING APPLICATIONS", the specification of which was filed on 09/20/2001, accorded Serial No. 09/957,407 and is identified by Attorney's Docket No. NUS-8.

I hereby claim priority benefits under Title 35, United States Code, Section 119(e), of United States Provisional Patent Application Serial No. 60/233,874, filed 09/20/00 by Swee Hin Teoh et al. for THREE-DIMENSIONAL BIORESORBABLE SCAFFOLDS FOR TISSUE ENGINEERING APPLICATIONS.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.


I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby appoint Pandiscio & Pandiscio, a firm composed of Nicholas A. Pandiscio, Registration No. 17293, Mark J. Pandiscio, Registration No. 30883, Scott R. Foster, Registration No. 20570, and James A. Sheridan, Registration No. 43,114 or any of them, of 470 Totten Pond Road, Waltham, Massachusetts 02451-1914, (Telephone No. 781-290-0060), my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with

the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's signature:



Inventor's full name:

Swee Hin Teoh

Date:

24 January 2002

Residence:

22 Toh Yi Road

Singapore 596504,

Republic of Singapore

Post office address:

same

Citizenship:

SINGAPORE

Inventor's signature:

D. W. Hutmacher

Inventor's full name:

Dietmar Werner Hutmacher

Date:

24 Jan 2002

Residence:

Upper Bukit Timah Road

48 Toh Tuck Road

Signature Park #03-07

Singapore

Republic of Singapore

Post office address:

same

Citizenship:

German

Inventor's signature:

Inventor's full name:

Kim Cheng Tan

Date:

Residence:

Blk 856D

Tampines St. 82, #12-180

Singapore 524856,

Republic of Singapore

Post office address:

same

Citizenship:

Inventor's signature: _____

Inventor's full name: Kock Fye Tam

Date: _____

Residence: Blk 659

Woodland Ring Road, #02-174

Singapore 730659,

Republic of Singapore

Post office address: same

Citizenship: _____

Inventor's signature: 

Inventor's full name: Iwan Zein

Date: 26 JANUARY 2002

Residence: Blk 7 Blk 867A

~~Siglap Road, #18-72 Tampines St 83~~

~~Mandarin Gardens #04-257~~

Singapore 448909, 521867

Republic of Singapore

Post office address: same

Citizenship: INDONESIAN

ALS/NUS8.DEC

NUS-8

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Inventor's signature: _____

Inventor's full name: Swee Hin Teoh

Date: _____

Residence: 22 Toh Yi Road


Singapore 596504,

Republic of Singapore

Post office address: same

Citizenship: _____

Inventor's signature: _____
Inventor's full name: Dietmar Werner Hutmacher
Date: _____
Residence: Upper Bukit Timah Road
48 Toh Tuck Road
Signature Park #03-07
Singapore
Republic of Singapore
Post office address: same
Citizenship: _____

Inventor's signature: 
Inventor's full name: Kim Cheng Tan
Date: 8 Feb 2002
Residence: Blk 856D
Tampines St. 82, #12-180
Singapore 524856,
Republic of Singapore
Post office address: same
Citizenship: SINGAPORE

Inventor's signature:

Z

Inventor's full name:

Kock Fye Tam

Date:

8- Feb. 2002.

Residence:

Blk 659

Woodland Ring Road, #02-174

Singapore 730659,

Republic of Singapore

Post office address:

same

Citizenship:

Singaporean

Inventor's signature:

Inventor's full name:

Iwan Zein

Date:

Residence:

Blk 7

Siglap Road, #18-72

Mandarin Gardens

Singapore 448909,

Republic of Singapore

Post office address:

same

Citizenship:

ALS/NUS8.DEC